501969101 06/26/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chang-Cheol LEE	06/05/2012
Hyun-jun KIM	06/05/2012
In-Young LEE	06/05/2012
Ki-Kwon JEONG	06/05/2012

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, Samsung-ro, Yeongtong-gu
Internal Address:	Gyeonggi-do
City:	Suwon-si
State/Country:	KOREA, REPUBLIC OF
Postal Code:	443-742

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13533473

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	Q129528
NAME OF SUBMITTER:	Alexandra Hamilton - Teams Specialist

Total Attachments: 1

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PATENT

REEL: 028446 FRAME: 0281

D \$40,00 13533473

Assignment

Whereas, We, Chang-Cheol LEE of Hwaseong-si, Republic of Korea; Hyun-jun KIM of Hwaseong-si, Republic of Korea; In-Young LEE of Yongin-si, Republic of Korea; and Ki-Kwon JEONG of Cheonan-si, Republic of Korea, hereinafter called assignors, have invented certain improvements in SEMICONDUCTOR PACKAGE INCLUDING SEMICONDUCTOR CHIP WITH THROUGH OPENING and executed an application for Letters Patent of the United States of America therefor on; and
Whereas, SAMSUNG ELECTRONICS CO., LTD. of 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;
Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,
We, the above named assignors, hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 U.S.C. §119, and we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.
We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100
Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in
parentheses (Application number and Confirmation number, filed) the application number, confirmation number and filing date of said application when known.
and filing date of said application when known.
Date: Chang Cheol Lee 2012. 66. 05 s/Chang-Cheol LEE
Date: Hyun Jun Kim 20/2 - 06.05 s/Hyun-jun KIM
Date: In Young Lee 2012.06.05 s/In-Young LEE
Date: Li Knon Joong 2012, 6, I s/Ki-Kwon JEONG
(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C.

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RECORDED: 06/26/2012

REEL: 028446 FRAME: 0282